

# MECHANICAL CASE OUTLINE

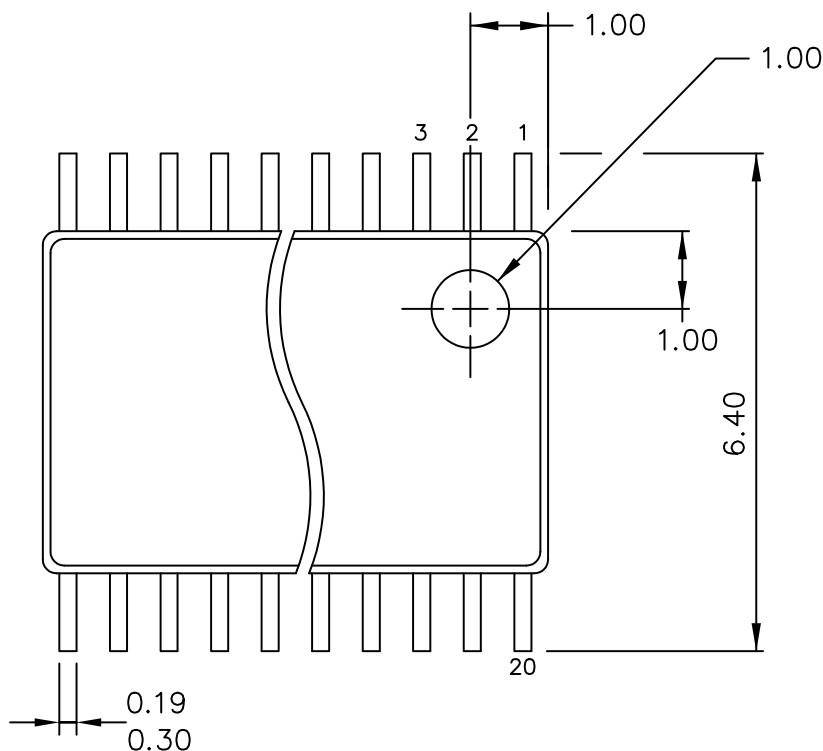
## PACKAGE DIMENSIONS

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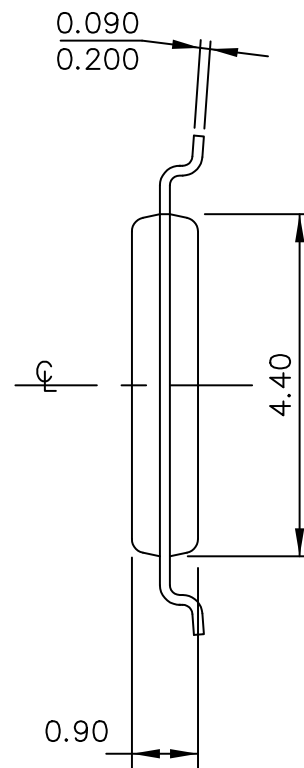


**TSSOP 20**  
CASE 948AD-01  
ISSUE O

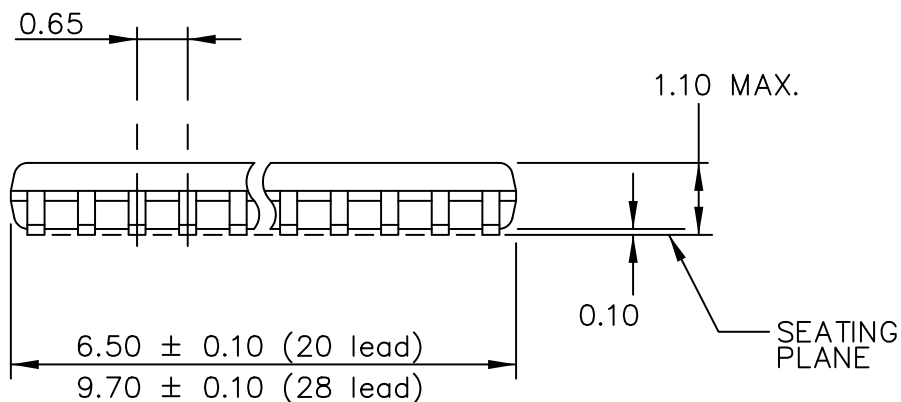
DATE 17 JUL 2008



TOP VIEW



END VIEW



SIDE VIEW

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